BOURNS®

Product Change Notification

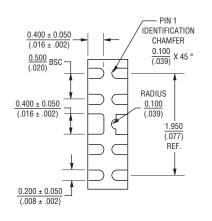
TVS DIODE PRODUCTS

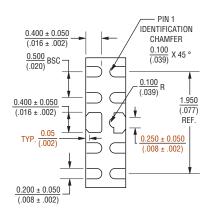
April, 2012



CDDFN10-0524P Pad Dimensions

In order to optimize the solder placement of devices mounted on PCB footprints, Bourns is modifying the center ground pad dimensions of the DFN package for our CDDFN10-0524P TVS diode products.





Before

After

Qualification:

Below are the Qualification Information and Results using the DFN10 package.

Qualification Information:

All Products	
Die Technology	TVS Diode Products
Product Name	CDDFN10-0524P
Top Metal	Al
Back Metal	AlNiAu
Assembly Site	China
Pins/Package	DFN10
Mold Compound	CEL9220
Die Attach	8006N
Bond Wire	Au
L/F Material	Copper
Marking	Laser
Termination Finish	Matte Sn (Pb Free)

Qualification Results:

	CDDFN10-0524P				
Stress Test	Conditions	Standard	Method	SS / Accept	SS/Fail
Moisture Induced Stress Sensitivity		J-STD-020	-	Level 3	66/0
HTSL	150°C,1000 h	J-STD-22	A103	22/0	22/0
PCT	85°C / 85 % RH, 1000 h	J-STD-22	A102	22/0	22/0
TCT	65 / +150 °C, 1000 cs	J-STD-22	A104	22/0	22/0
THT	65 / +150 °C, 1000 cs	J-STD-22	A101	22/0	22/0
Solderability	8 hr Steam	JESD22-	B102E	5/0	5/0

Note: Samples subjected are preconditioned according to *J-STD22-020D* (260 °C).

Product Labeling:

The product marking is unchanged except for the country code information. Labels will show the country of origin code.

Identification of the Changed Product:

Bourns maintains traceability back to source wafer lots and assembly sites for all products.

First Date Code from New Site: 1239

Impact on Form, Fit, Function and Reliability:

Product ratings and electrical characteristics are unaffected by the change. There is no impact on form, fit, function or reliability.

Last Date of Manufacture of Existing Product:

Bourns has no plans to discontinue assembly and test of products at its existing subcontract sites.

Implementation Date:

Deliveries to customers using the new pad layout may occur from October, 2012 onward.

If you have any questions, please contact our customer service teams in each region.